Diode Module

# **STARPOWER**

SEMICONDUCTOR

# FRED

# FD300CCH60C1S

**Molding Type Module** 

600V/300A 2 in one-package



# **General Description**

STARPOWER Diode Power Module provides low forward voltage as well as low reverse recovery loss. They are designed for the applications such as SMPS.

#### Features

- Fast soft diode
- Low forward voltage drop
- Small temperature coefficient
- Low reverse recovery losses
- High ruggedness
- Low inductance
- Isolated copper baseplate using DBC technology

# **Typical Applications**

- SMPS
- PFC
- Electric welders
- DC choppers

Symbol	Description	FD300CCH60C1S	Unit
V <sub>RRM</sub>	Repetitive Peak Reverse Voltage	600	V
I <sub>F</sub>	Continuous Forward Current	300	А
I <sub>FRM</sub>	Repetitive Peak Forward Current	600	Α
P <sub>D</sub>	Maximum Power Dissipation @ T <sub>j</sub> =150°C	598	W
T <sub>jmax</sub>	Maximum Junction Temperature	150	°C
T <sub>jop</sub>	Operating Junction Temperature	-40 to +125	°C
T <sub>STG</sub>	Storage Temperature Range	-40 to +125	°C
V <sub>ISO</sub>	Isolation Voltage RMS,f=50Hz,t=1min	4000	V
М	Terminal Connection Torque, Screw M5	2.5 to 5.0	N.m
	Mounting Torque, Screw M6	3.0 to 5.0	IN.III
G	Weight of Module	150	g

#### Absolute Maximum Ratings $T_C=25$ °C unless otherwise noted

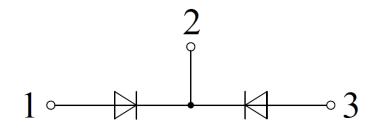
## **Electrical Characteristics of Diode** $T_C=25$ °C unless otherwise noted

Symbol	Parameter	Test Conditions		Min.	Тур.	Max.	Unit
$V_{\rm F}$	Diode Forward	I <sub>F</sub> =300A	T <sub>j</sub> =25℃		1.40	1.80	v
	Voltage		Tj=125℃		1.45		
I <sub>R</sub>	Diode Reverse	V <sub>R</sub> =V <sub>RRM</sub>	$T_j=25^{\circ}C$			1.0	mA
	Current					1.0	
Qr	Recovered	I <sub>F</sub> =300A V <sub>R</sub> =300V di/dt=-5500A/μs	T <sub>i</sub> =25℃		16.4		μC
	Charge		Tj=125℃		22.0		
I <sub>RM</sub>	Peak Reverse		T <sub>j</sub> =25℃		205		Α
	Recovery Current		T <sub>i</sub> =125℃		265		
E <sub>rec</sub>	Reverse Recovery		T <sub>i</sub> =25℃		2.66		mI
	Energy		T <sub>i</sub> =125℃		5.12		mJ
L <sub>CE</sub>	Stray Inductance					30	nH
R <sub>CC'+EE'</sub>	Module Lead						
	Resistance,	$T_C=25$ °C		0.75		mΩ	
	Terminal To Chip						

#### **Thermal Characteristics**

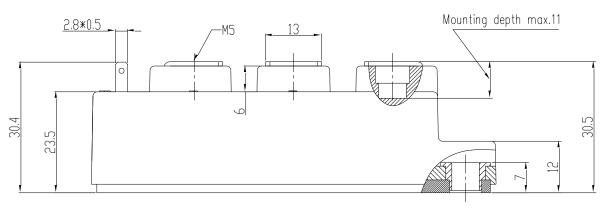
Symbol	Parameter	Тур.	Max.	Unit
$R_{\theta JC}$	Junction-to-Case (per Diode)		0.209	K/W
$R_{\theta CS}$	Case-to-Sink (Conductive grease applied)	0.05		K/W

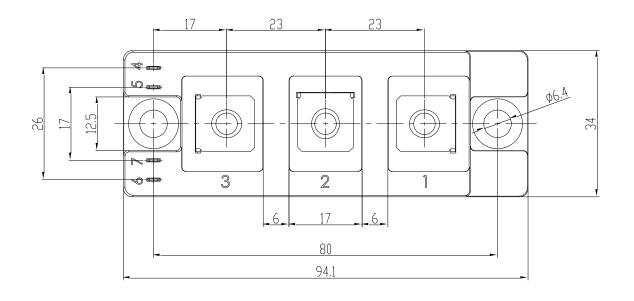
## **Equivalent Circuit Schematic**



## **Package Dimensions**

Dimensions in Millimeters





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